



## Legacy LPSDR/LPDDR VFBGA Assembly Site Transfer

PCN: 33172

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**Type:** Manufacturing Site “Change or Addition

**Description:** The assembly site of legacy LPSDR/LPDDR in VFBGA package will transfer from SPIL to ASE Chung Li, Taiwan.  
 Assembly at the current site will end by October 2019 and customers should be ready to receive parts from the new assembly site.

**Site Locations:**

- Current: Siliconware Precision Industries Co., No. 8, Sec 2 Chang Hsin Rd, Hemei, Changhua, Taiwan 508
- New: ASE Chung Li - Advanced Semiconductor Engineering, 550 Chung Hwa Road, Chungli, Taiwan 320

**Reason:** Manufacturing Efficiency, Supply Flexibility/Security

**Product Affected:** T67M, T68M in VFBGA 60 ball and 90 ball package Y67M in VFBGA 54 ball and 90 ball package

Affected Micron Part Number Component	Recommended Replacement	Customer Part Number
MT46H16M32LFB5-5 IT:C		557-1899-2-ND
MT46H16M32LFB5-6 AIT:C		557-1900-2-ND
MT46H16M32LFB5-6 AT:C		557-1901-2-ND
MT46H16M32LFBQ-5 AAT:C		557-1902-2-ND
MT46H32M16LFBF-5 AIT:C		557-1903-2-ND
MT46H32M16LFBF-5 IT:C		557-1627-ND, 557-1904-2-ND
MT46H32M16LFBF-6 AAT:C		557-1905-2-ND
MT46H32M16LFBF-6 AT:C		557-1906-2-ND
MT46H32M32LFB5-5 AAT:B		557-1907-2-ND
MT46H32M32LFB5-5 AIT:B		557-1908-2-ND
MT46H32M32LFB5-5 IT:B		557-1909-2-ND
MT46H64M16LFBF-5 AIT:B		557-1911-2-ND
MT46H64M16LFBF-5 IT:B		557-1626-ND, 557-1912-2-ND
MT48H16M32LFB5-6 IT:C		557-1929-2-ND
MT48H32M16LFB4-6 IT:C		557-1931-2-ND

\*Materials that have been ordered are in bold.

**Method of Identification:** Date code

**Micron Sites Affected:** Subcontractor

**Sample Available:** 2019-05-30

**Qual Data Available:** 2019-05-30

**Product Ship Date:** 2019-08-30

NOTE: Per JEDEC Standard JESD46-C Section 3.2.3; lack of acknowledgment of this PCN within 30 days constitutes acceptance of change.

**Micron Confidential and Proprietary Information**

## Attachments

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There are no attachments on this PCN